Inert Gas bubble formation in sputtered CdTe thin film solar cells.

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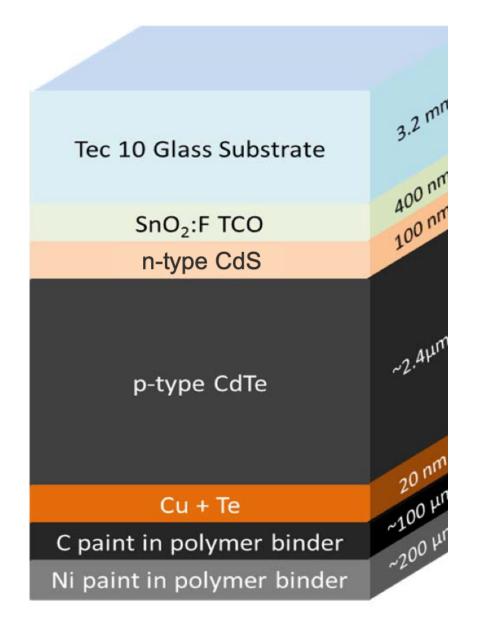


<u>Contents</u>

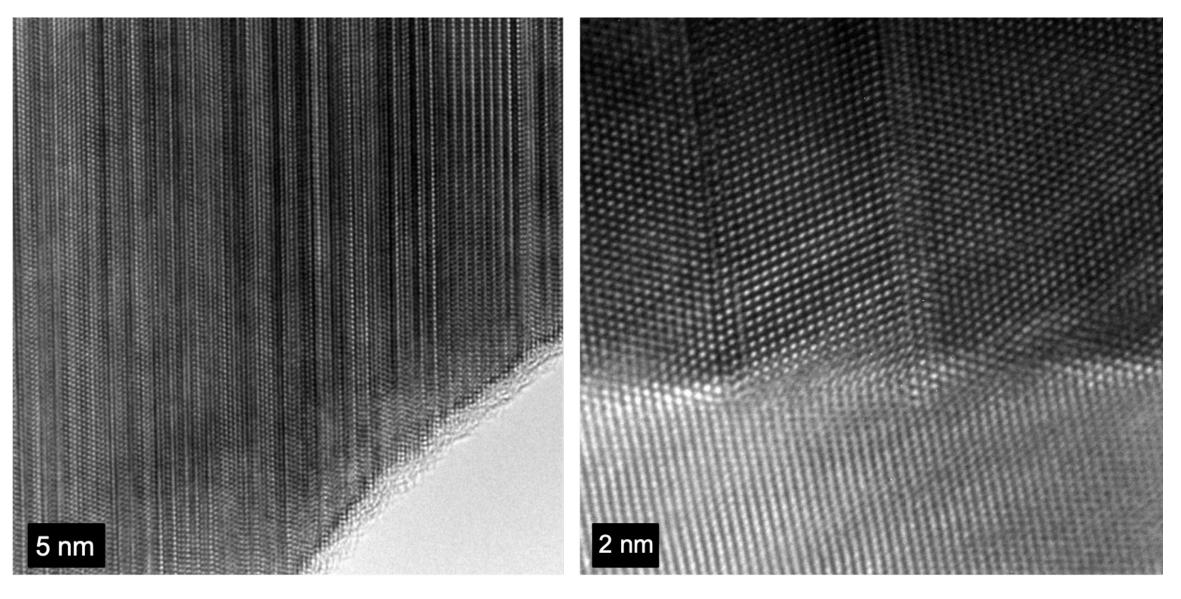
- Experimental results
- Modelling Methodology
- Results
 - Ar/Xe incorporation
 - Ar/Xe diffusion in Zinc Blende and Wurtzite CdTe
 - Bubble Growth and Restriction Mechanisms
- Conclusion

CdTe Solar Cells

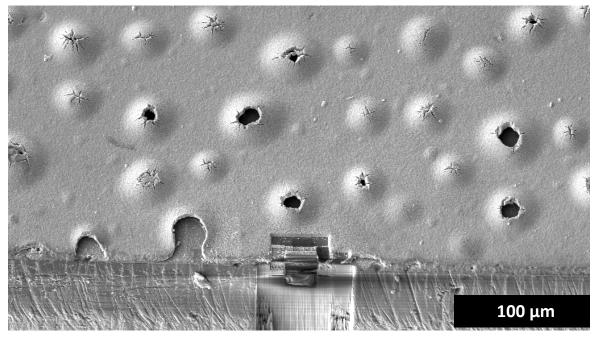
- CdTe cells are competitive with silicon cells
- Current production method is closed space sublimation (First Solar).
- The current best research cell efficiency is 22.1% but the maximum efficiency is 33.7%.



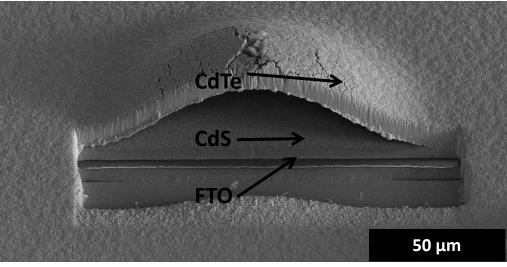
Removal of Stacking Faults



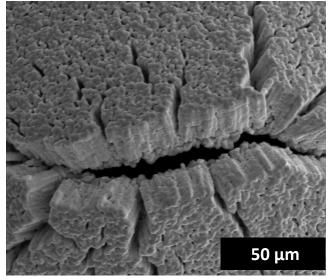
Pulsed DC sputtered CdTe after the cadmium chloride activation at 400°C



- An SEM image of a sputtered device following activation with CdCl₂.
- Blisters appear on the surface.
- Blisters caused by working gas in magnetron

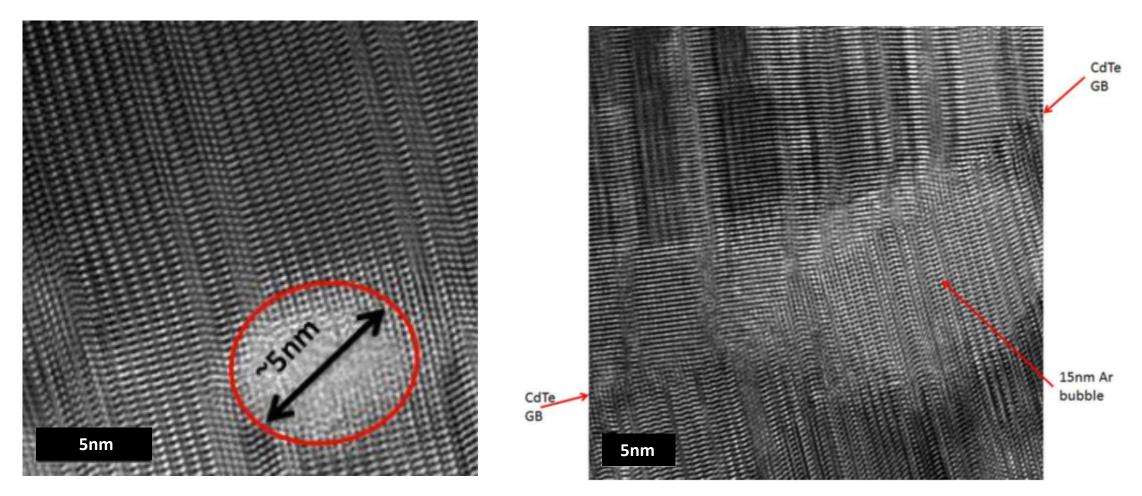


Delamination occurs at the CdS/CdTe junction.



 Exfoliation occurs at some surface blisters.

Argon in CdTe after RTP at 400 ° C for 12 hours



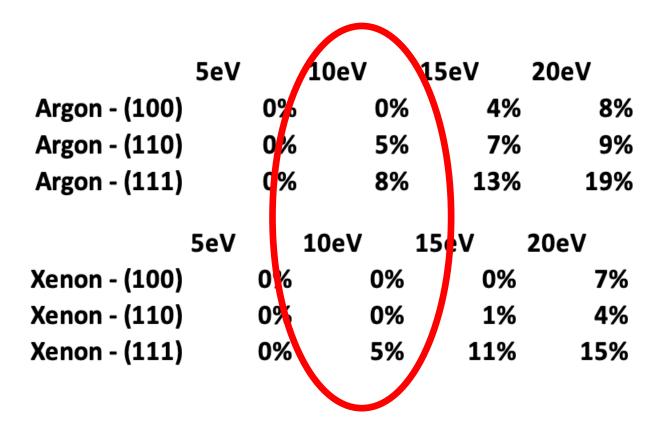
- Argon incorporated during sputtering
- Argon agglomerates into ~5-15 nm clusters.

Methodology

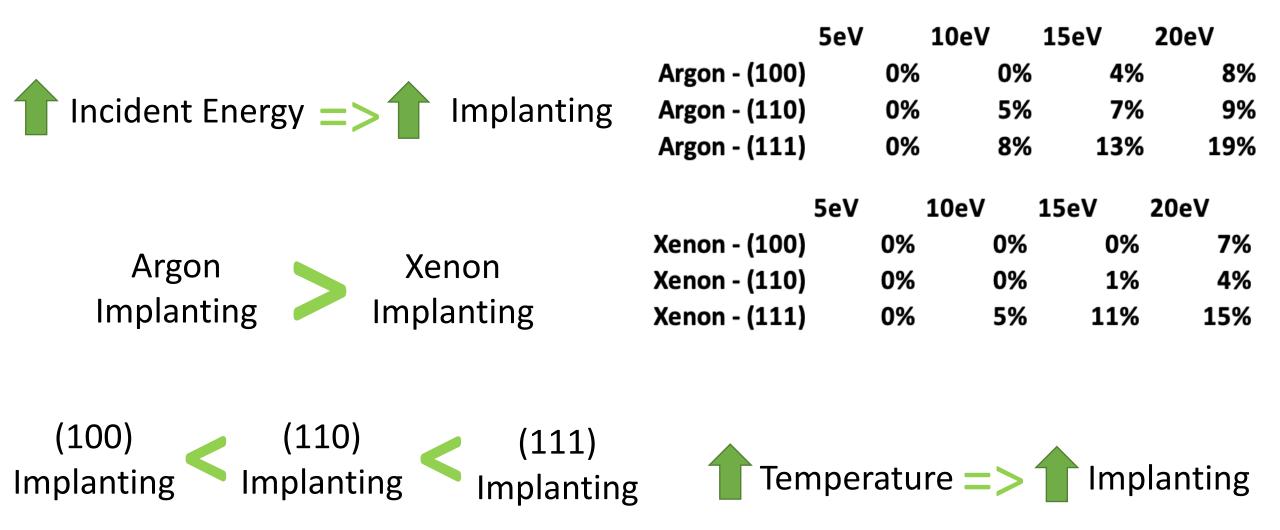
- Atomistic Simulation using the Molecular Dynamics (MD) package LAMMPS with the force fields:
 - Stillinger-Weber for Bulk CdTe,
 - ZBL potential for Ar/Xe CdTe interactions,
 - Lennard Jones potential for Ar-Ar and Xe-Xe interactions parameterised by Ashcroft and Mermin.
- Nudged Elastic Band (NEB) for diffusion pathways and energy barriers.
- Arrhenius' equation was linearised to estimate Arrhenius prefactors and hence determine transition time.
- ParSplice is also used to observe transitions at temperatures below 800 K in some cases.

Zinc-Blende CdTe

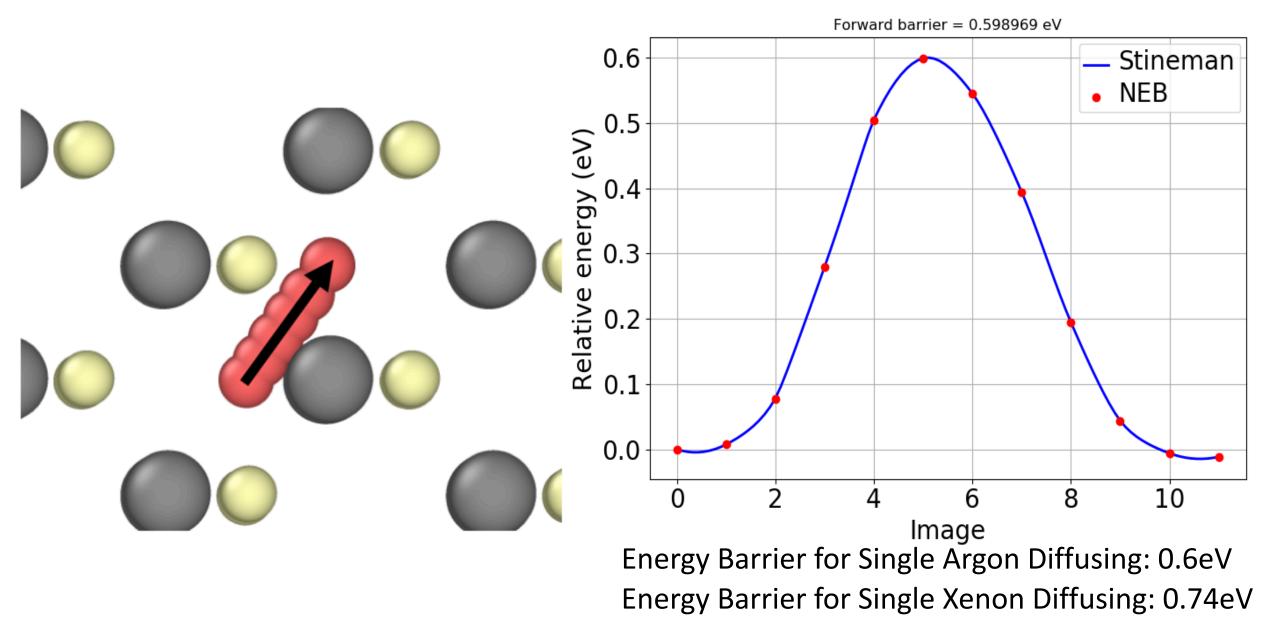
Normal Impact of Ar/Xe on Zinc-Blende CdTe



Normal Impact of Ar/Xe on Zinc-Blende CdTe



Single Ar Diffusion in zinc blende CdTe Crystal

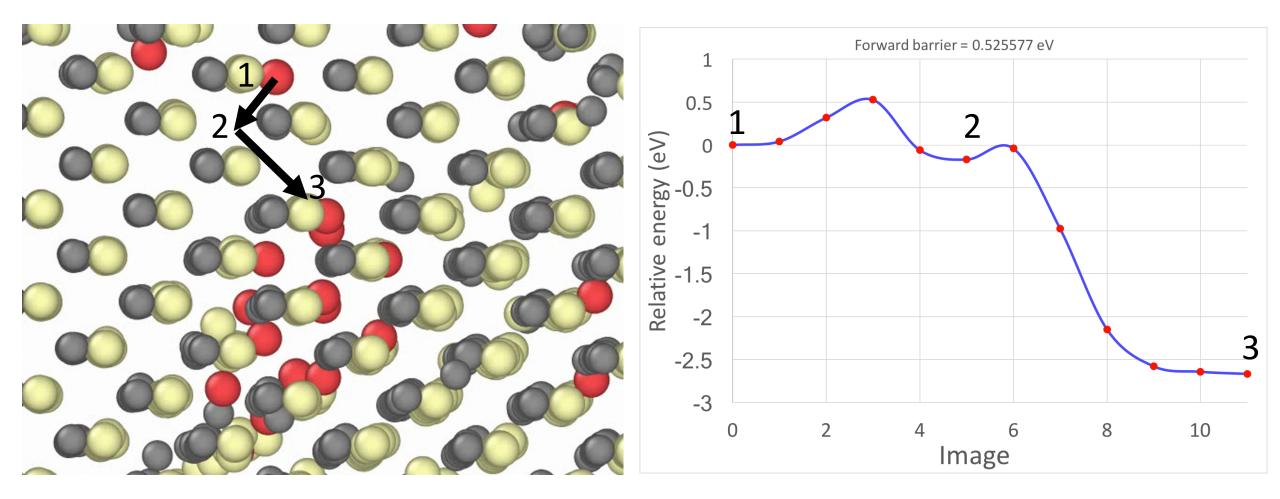


1ns simulation of 4% Argon in CdTe lattice at 723C (1000K) with CdTe removed for visibility (Final State)



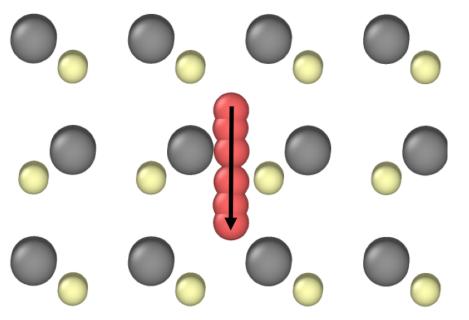
- Ar clusters have begun to form even at this short time scale.
- Xenon clusters grow in a similarly in the same conditions.
- Xenon distributed and annealed at 1000 K for 3 ns has final distribution similar to Ar annealed for 750 ps.
- Xenon clusters will grow under experimental time scales

Ar Cluster Growth



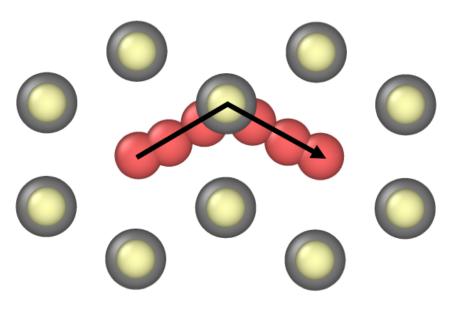
Low diffusion barriers (~0.53 eV and ~0.25 eV) for single Ar joining cluster. High reverse barrier (~2.5 eV) for single Ar to leave cluster.

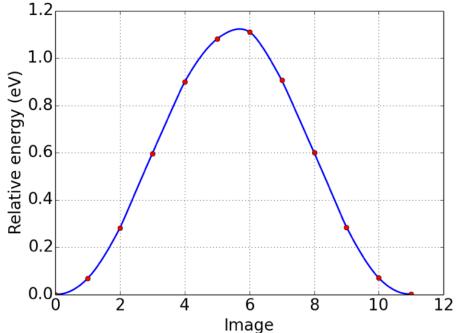
Wurtzite CdTe



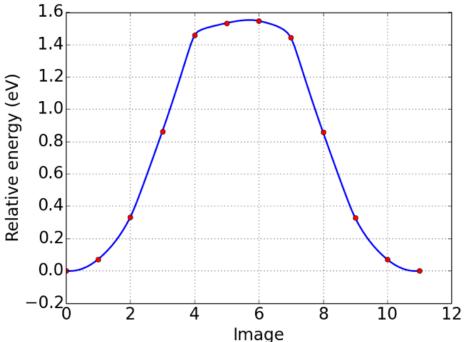
Wurtzite Diffusion

 Two non-equivalent pathways with energy barriers 1.12 eV and 1.54 eV.



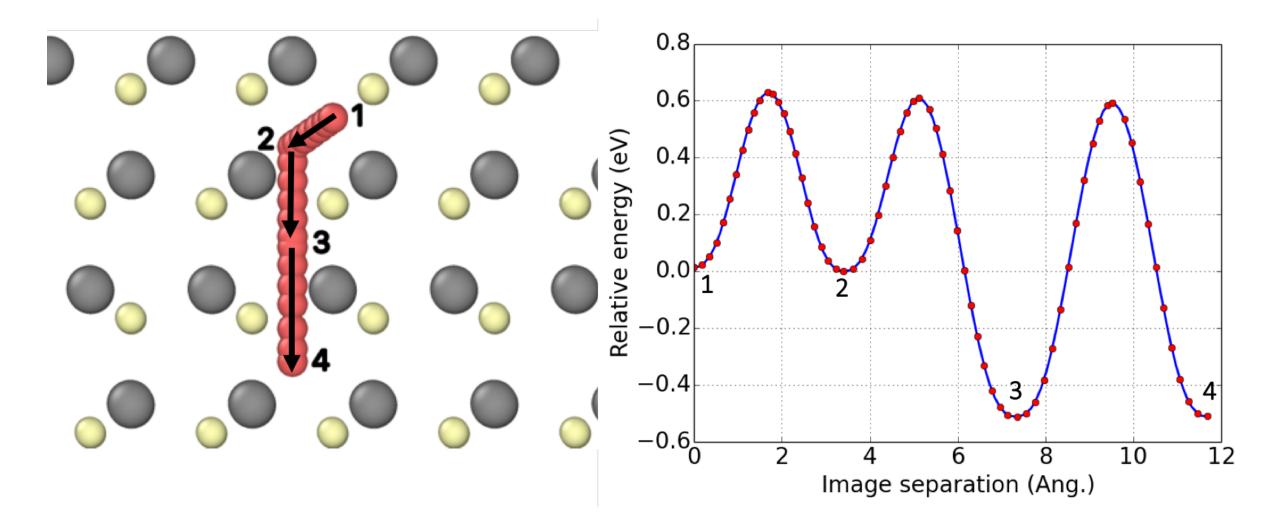


- Above 800 K barrier is ~0.67 eV.
 Below 800 K barrier is ~1.4 eV.
- Xe pathways are the same but the barriers are 1.4 eV and 2 eV.



CdTe Stacking Faults

Transitions across stacking faults



Conclusions

Experimental:

- 5-15 nm Ar clusters form during in RTA of pulsed dc sputtered films
- $CdCl_2$ treatment causes μm sized blisters at the same temperature.

Simulation:

- Ar penetrates at <10 eV, threshold more with Xe -> Use Xe as working gas ?
- Diffusion barriers are lowered near clusters causing cluster growth.
- Clusters grow by diffusion of single atoms, minimising lattice distortion
- High barrier heights in wurzite mean that the bubble growth is inhibited by stacking faults; when they are removed (as after CdCl₂treatment) µm sized bubbles can form

Thank You!

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